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Details

Product Status	Obsolete
Core Processor	80C51
Core Size	8-Bit
Speed	60MHz
Connectivity	SPI, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	50
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LQFP
Supplier Device Package	44-VQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/at89c51ed2-rdtim

Table 13. Pin Description (Continued)

Mnemonic	Pin Number					Type	Name and Function
	PLCC44	VQFP44	PLCC68	VQFP64	PDIL40		
	9	3	29	20	8	I/O	P1.7: Input/Output:
						I/O	CEX4: Capture/Compare External I/O for PCA module 4
						I/O	MOSI: SPI Master Output Slave Input line When SPI is in master mode, MOSI outputs data to the slave peripheral. When SPI is in slave mode, MOSI receives data from the master controller.
XTALA1	21	15	49	38	19	I	XTALA 1: Input to the inverting oscillator amplifier and input to the internal clock generator circuits.
XTALA2	20	14	48	37	18	O	XTALA 2: Output from the inverting oscillator amplifier
P2.0 - P2.7	24 - 31	18 - 25	54, 55, 56, 58, 59, 61, 64, 65	43, 44, 45, 47, 48, 50, 53, 54	21-28	I/O	Port 2: Port 2 is an 8-bit bidirectional I/O port with internal pull-ups. Port 2 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 2 pins that are externally pulled low will source current because of the internal pull-ups. Port 2 emits the high-order address byte during fetches from external program memory and during accesses to external data memory that use 16-bit addresses (MOVX @DPTR). In this application, it uses strong internal pull-ups emitting 1s. During accesses to external data memory that use 8-bit addresses (MOVX @Ri), port 2 emits the contents of the P2 SFR.
P3.0 - P3.7	11, 13 - 19	5, 7 - 13	34, 39, 40, 41, 42, 43, 45, 47	25, 28, 29, 30, 31, 32, 34, 36	10-17	I/O	Port 3: Port 3 is an 8-bit bidirectional I/O port with internal pull-ups. Port 3 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 3 pins that are externally pulled low will source current because of the internal pull-ups. Port 3 also serves the special features of the 80C51 family, as listed below.
	11	5	34	25	10	I	RXD (P3.0): Serial input port
	13	7	39	28	11	O	TXD (P3.1): Serial output port
	14	8	40	29	12	I	INT0 (P3.2): External interrupt 0
	15	9	41	30	13	I	INT1 (P3.3): External interrupt 1
	16	10	42	31	14	I	T0 (P3.4): Timer 0 external input
	17	11	43	32	15	I	T1 (P3.5): Timer 1 external input
	18	12	45	34	16	O	WR (P3.6): External data memory write strobe
	19	13	47	36	17	O	RD (P3.7): External data memory read strobe
P4.0 - P4.7	-	-	20, 24, 26, 44, 46, 50, 53, 57	11, 15, 17, 33, 35, 39, 42, 46	-	I/O	Port 4: Port 4 is an 8-bit bidirectional I/O port with internal pull-ups. Port 4 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 4 pins that are externally pulled low will source current because of the internal pull-ups.
P5.0 - P5.7	-	-	60, 62, 63, 7, 8, 10, 13, 16	49, 51, 52, 62, 63, 1, 4, 7	-	I/O	Port 5: Port 5 is an 8-bit bidirectional I/O port with internal pull-ups. Port 5 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 5 pins that are externally pulled low will source current because of the internal pull-ups.
RST	10	4	30	21	9	I	Reset: A high on this pin for two machine cycles while the oscillator is running, resets the device. An internal diffused resistor to V _{SS} permits a power-on reset using only an external capacitor to V _{CC} . This pin is an output when the hardware watchdog forces a system reset.

Table 16. CKCON0 Register

CKCON0 - Clock Control Register (8Fh)

7	6	5	4	3	2	1	0
-	WDX2	PCAX2	SIX2	T2X2	T1X2	T0X2	X2

Bit Number	Bit Mnemonic	Description
7	Reserved	The values for this bit are indeterminate. Do not set this bit.
6	WDX2	Watchdog Clock (This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Cleared to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.
5	PCAX2	Programmable Counter Array Clock (This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Cleared to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.
4	SIX2	Enhanced UART Clock (Mode 0 and 2) (This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Cleared to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.
3	T2X2	Timer2 Clock (This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Cleared to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.
2	T1X2	Timer1 Clock (This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Cleared to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.
1	T0X2	Timer0 Clock (This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Cleared to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.
0	X2	CPU Clock Cleared to select 12 clock periods per machine cycle (STD mode) for CPU and all the peripherals. Set to select 6 clock periods per machine cycle (X2 mode) and to enable the individual peripherals'X2' bits. Programmed by hardware after Power-up regarding Hardware Security Byte (HSB). Default setting, X2 is cleared.

Reset Value = 0000 000'HSB. X2'b (See "Hardware Security Byte")

Not bit addressable

Table 17. CKCON1 Register

CKCON1 - Clock Control Register (AFh)

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	SPIX2

Bit Number	Bit Mnemonic	Description
7	-	Reserved
6	-	Reserved
5	-	Reserved
4	-	Reserved
3	-	Reserved
2	-	Reserved
1	-	Reserved
0	SPIX2	SPI (This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Clear to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.

Reset Value = XXXX XXX0b

Not bit addressable

Power Monitor

The POR/PFD function monitors the internal power-supply of the CPU core memories and the peripherals, and if needed, suspends their activity when the internal power supply falls below a safety threshold. This is achieved by applying an internal reset to them.

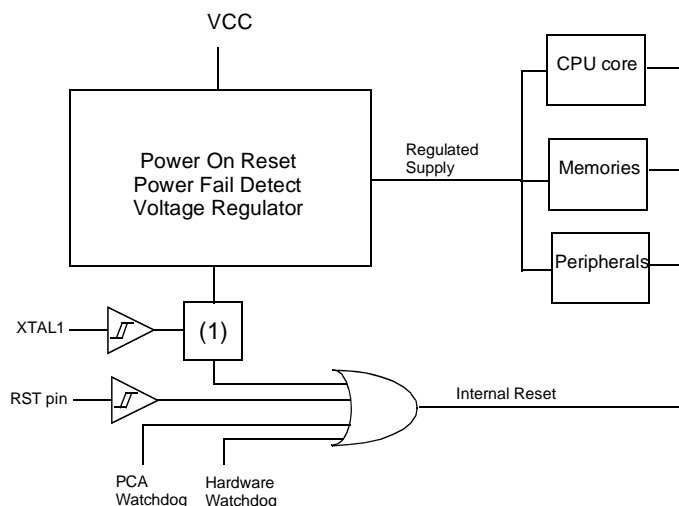
By generating the Reset the Power Monitor insures a correct start up when AT89C51RD2/ED2 is powered up.

Description

In order to startup and maintain the microcontroller in correct operating mode, V_{CC} has to be stabilized in the V_{CC} operating range and the oscillator has to be stabilized with a nominal amplitude compatible with logic level VIH/VIL.

These parameters are controlled during the three phases: power-up, normal operation and power going down. See Figure 12.

Figure 12. Power Monitor Block Diagram



Note: 1. Once XTAL1 High and low levels reach above and below VIH/VIL, a 1024 clock period delay will extend the reset coming from the Power Fail Detect. If the power falls below the Power Fail Detect threshold level, the Reset will be applied immediately.

The Voltage regulator generates a regulated internal supply for the CPU core the memories and the peripherals. Spikes on the external Vcc are smoothed by the voltage regulator.

Timer 2

The Timer 2 in the AT89C51RD2/ED2 is the standard C52 Timer 2. It is a 16-bit timer/counter: the count is maintained by two eight-bit timer registers, TH2 and TL2 are cascaded. It is controlled by T2CON (Table 20) and T2MOD (Table 21) registers. Timer 2 operation is similar to Timer 0 and Timer 1. $C/\overline{T}2$ selects $F_{OSC}/12$ (timer operation) or external pin T2 (counter operation) as the timer clock input. Setting TR2 allows TL2 to increment by the selected input.

Timer 2 has 3 operating modes: capture, autoreload and Baud Rate Generator. These modes are selected by the combination of RCLK, TCLK and CP/RL2 (T2CON).

Refer to the Atmel 8-bit Microcontroller Hardware Manual for the description of Capture and Baud Rate Generator Modes.

Timer 2 includes the following enhancements:

- Auto-reload mode with up or down counter
- Programmable clock-output

Auto-reload Mode

The auto-reload mode configures Timer 2 as a 16-bit timer or event counter with automatic reload. If DCEN bit in T2MOD is cleared, Timer 2 behaves as in 80C52 (refer to the Atmel C51 Microcontroller Hardware Manual). If DCEN bit is set, Timer 2 acts as an Up/down timer/counter as shown in Figure 14. In this mode the T2EX pin controls the direction of count.

When T2EX is high, Timer 2 counts up. Timer overflow occurs at FFFFh which sets the TF2 flag and generates an interrupt request. The overflow also causes the 16-bit value in RCAP2H and RCAP2L registers to be loaded into the timer registers TH2 and TL2.

When T2EX is low, Timer 2 counts down. Timer underflow occurs when the count in the timer registers TH2 and TL2 equals the value stored in RCAP2H and RCAP2L registers. The underflow sets TF2 flag and reloads FFFFh into the timer registers.

The EXF2 bit toggles when Timer 2 overflows or underflows according to the direction of the count. EXF2 does not generate any interrupt. This bit can be used to provide 17-bit resolution.

Serial I/O Port

The serial I/O port in the AT89C51RD2/ED2 is compatible with the serial I/O port in the 80C52.

It provides both synchronous and asynchronous communication modes. It operates as a Universal Asynchronous Receiver and Transmitter (UART) in three full-duplex modes (Modes 1, 2 and 3). Asynchronous transmission and reception can occur simultaneously and at different baud rates

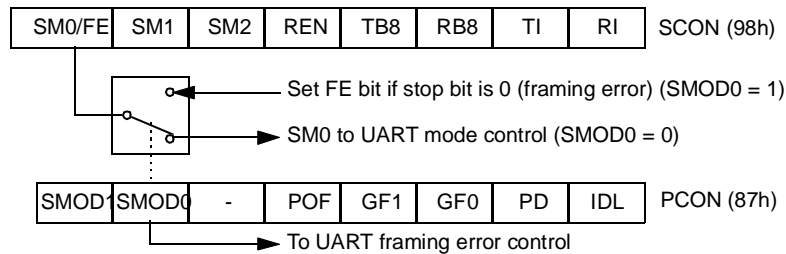
Serial I/O port includes the following enhancements:

- Framing error detection
- Automatic address recognition

Framing Error Detection

Framing bit error detection is provided for the three asynchronous modes (modes 1, 2 and 3). To enable the framing bit error detection feature, set SMOD0 bit in PCON register (See Figure 22).

Figure 22. Framing Error Block Diagram



When this feature is enabled, the receiver checks each incoming data frame for a valid stop bit. An invalid stop bit may result from noise on the serial lines or from simultaneous transmission by two CPUs. If a valid stop bit is not found, the Framing Error bit (FE) in SCON register (See Table 33.) bit is set.

Software may examine FE bit after each reception to check for data errors. Once set, only software or a reset can clear FE bit. Subsequently received frames with valid stop bits cannot clear FE bit. When FE feature is enabled, RI rises on stop bit instead of the last data bit (See Figure 23. and Figure 24.).

Figure 23. UART Timings in Mode 1

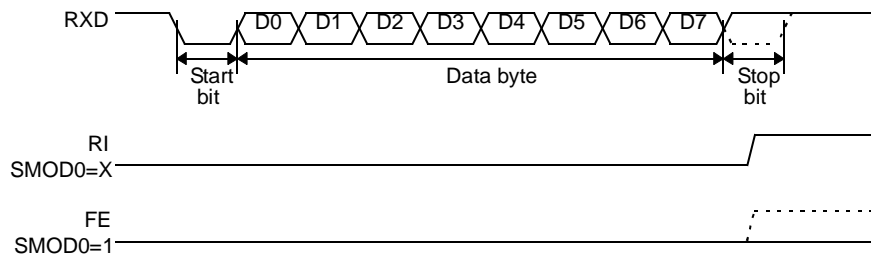
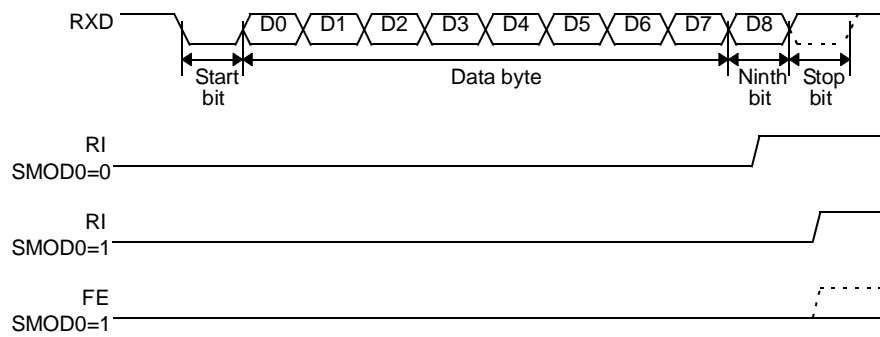


Figure 24. UART Timings in Modes 2 and 3



Automatic Address Recognition

The automatic address recognition feature is enabled when the multiprocessor communication feature is enabled (SM2 bit in SCON register is set).

Implemented in hardware, automatic address recognition enhances the multiprocessor communication feature by allowing the serial port to examine the address of each incoming command frame. Only when the serial port recognizes its own address, the receiver sets RI bit in SCON register to generate an interrupt. This ensures that the CPU is not interrupted by command frames addressed to other devices.

If desired, the user may enable the automatic address recognition feature in mode 1. In this configuration, the stop bit takes the place of the ninth data bit. Bit RI is set only when the received command frame address matches the device's address and is terminated by a valid stop bit.

To support automatic address recognition, a device is identified by a given address and a broadcast address.

Note: The multiprocessor communication and automatic address recognition features cannot be enabled in mode 0 (i. e. setting SM2 bit in SCON register in mode 0 has no effect).

Given Address

Each device has an individual address that is specified in SADDR register; the SADEN register is a mask byte that contains don't-care bits (defined by zeros) to form the device's given address. The don't-care bits provide the flexibility to address one or more slaves at a time. The following example illustrates how a given address is formed.

To address a device by its individual address, the SADEN mask byte must be 1111 1111b.

For example:

```
SADDR0101 0110b
SADEN1111 1100b
Given0101 01XXb
```

The following is an example of how to use given addresses to address different slaves:

```
Slave A:SADDR1111 0001b
SADEN1111 1010b
Given1111 0X0Xb
```

```
Slave B:SADDR1111 0011b
SADEN1111 1001b
Given1111 0XX1b
```

```
Slave C:SADDR1111 0010b
SADEN1111 1101b
Given1111 00X1b
```


Table 38. SBUF Register

SBUF - Serial Buffer Register for UART (99h)

7	6	5	4	3	2	1	0

Reset Value = XXXX XXXXb

Table 39. BRL Register

BRL - Baud Rate Reload Register for the internal baud rate generator, UART (9Ah)

7	6	5	4	3	2	1	0

Reset Value = 0000 0000b

Table 40. T2CON Register

T2CON - Timer 2 Control Register (C8h)

7	6	5	4	3	2	1	0
TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2#	CP/RL2#
Bit Number	Bit Mnemonic	Description					
7	TF2	Timer 2 overflow Flag Must be cleared by software. Set by hardware on timer 2 overflow, if RCLK = 0 and TCLK = 0.					
6	EXF2	Timer 2 External Flag Set when a capture or a reload is caused by a negative transition on T2EX pin if EXEN2=1. When set, causes the CPU to vector to timer 2 interrupt routine when timer 2 interrupt is enabled. Must be cleared by software. EXF2 doesn't cause an interrupt in Up/down counter mode (DCEN = 1)					
5	RCLK	Receive Clock bit for UART Cleared to use timer 1 overflow as receive clock for serial port in mode 1 or 3. Set to use timer 2 overflow as receive clock for serial port in mode 1 or 3.					
4	TCLK	Transmit Clock bit for UART Cleared to use timer 1 overflow as transmit clock for serial port in mode 1 or 3. Set to use timer 2 overflow as transmit clock for serial port in mode 1 or 3.					
3	EXEN2	Timer 2 External Enable bit Cleared to ignore events on T2EX pin for timer 2 operation. Set to cause a capture or reload when a negative transition on T2EX pin is detected, if timer 2 is not used to clock the serial port.					
2	TR2	Timer 2 Run control bit Cleared to turn off timer 2. Set to turn on timer 2.					
1	C/T2#	Timer/Counter 2 select bit Cleared for timer operation (input from internal clock system: $F_{CLK\ PERIPH}$). Set for counter operation (input from T2 input pin, falling edge trigger). Must be 0 for clock out mode.					
0	CP/RL2#	Timer 2 Capture/Reload bit If RCLK=1 or TCLK=1, CP/RL2# is ignored and timer is forced to auto-reload on timer 2 overflow. Cleared to auto-reload on timer 2 overflows or negative transitions on T2EX pin if EXEN2=1. Set to capture on negative transitions on T2EX pin if EXEN2=1.					

Reset Value = 0000 0000b

Bit addressable

Figure 32. Data Transmission Format (CPHA = 0)

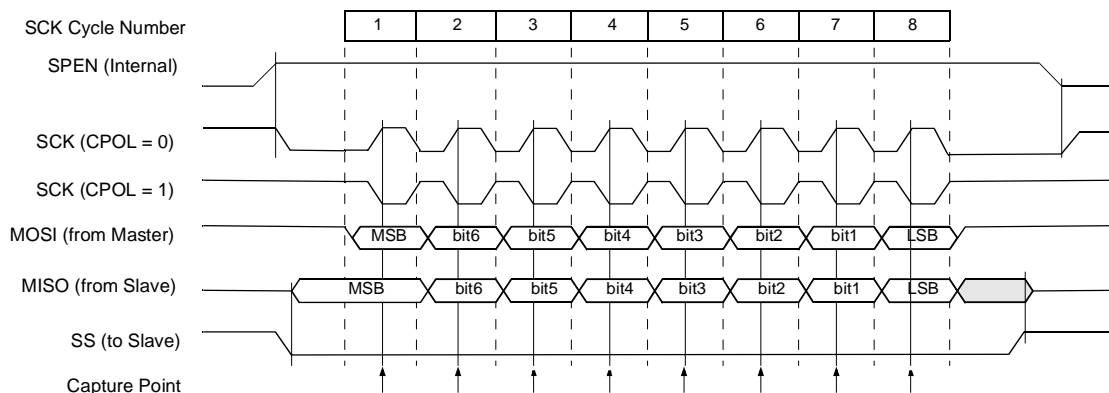


Figure 33. Data Transmission Format (CPHA = 1)

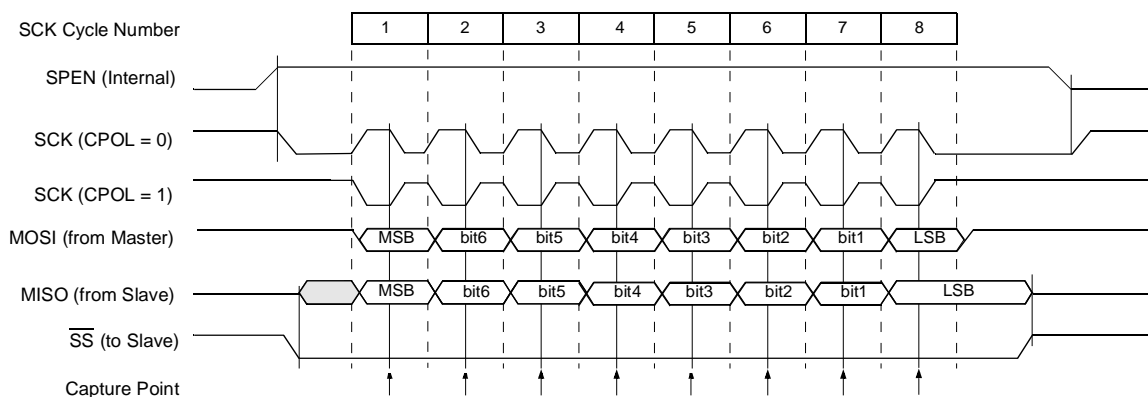
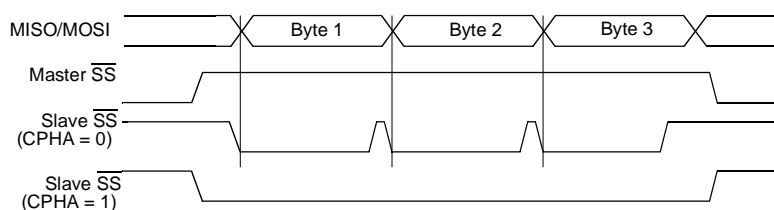


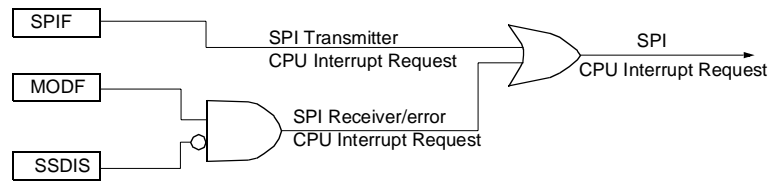
Figure 34. CPHA/SS Timing



As shown in Figure 32, the first SCK edge is the MSB capture strobe. Therefore, the Slave must begin driving its data before the first SCK edge, and a falling edge on the \overline{SS} pin is used to start the transmission. The \overline{SS} pin must be toggled high and then low between each Byte transmitted (Figure 34).

Figure 33 shows an SPI transmission in which CPHA is '1'. In this case, the Master begins driving its MOSI pin on the first SCK edge. Therefore, the Slave uses the first SCK edge as a start transmission signal. The \overline{SS} pin can remain low between transmissions (Figure 34). This format may be preferred in systems having only one Master and only one Slave driving the MISO data line.

Figure 35. SPI Interrupt Requests Generation



Registers

Serial Peripheral Control Register (SPCON)

There are three registers in the Module that provide control, status and data storage functions. These registers are describes in the following paragraphs.

- The Serial Peripheral Control Register does the following:
- Selects one of the Master clock rates
- Configure the SPI Module as Master or Slave
- Selects serial clock polarity and phase
- Enables the SPI Module
- Frees the SS pin for a general-purpose

Table 48 describes this register and explains the use of each bit

Table 48. SPCON Register

SPCON - Serial Peripheral Control Register (0C3H)

7	6	5	4	3	2	1	0
SPR2	SPEN	SSDIS	MSTR	CPOL	CPHA	SPR1	SPR0
Bit Number	Bit Mnemonic	Description					
7	SPR2	Serial Peripheral Rate 2 Bit with SPR1 and SPR0 define the clock rate.					
6	SPEN	Serial Peripheral Enable Cleared to disable the SPI interface. Set to enable the SPI interface.					
5	SSDIS	\overline{SS} Disable Cleared to enable \overline{SS} in both Master and Slave modes. Set to disable \overline{SS} in both Master and Slave modes. In Slave mode, this bit has no effect if CPHA = '0'. When SSDIS is set, no MODF interrupt request is generated.					
4	MSTR	Serial Peripheral Master Cleared to configure the SPI as a Slave. Set to configure the SPI as a Master.					
3	CPOL	Clock Polarity Cleared to have the SCK set to '0' in idle state. Set to have the SCK set to '1' in idle low.					
2	CPHA	Clock Phase Cleared to have the data sampled when the SCK leaves the idle state (see CPOL). Set to have the data sampled when the SCK returns to idle state (see CPOL).					

Interrupt Sources and Vector Addresses

Table 52. Interrupt Sources and Vector Addresses

Number	Polling Priority	Interrupt Source	Interrupt Request	Vector Address
0	0	Reset		0000h
1	1	INT0	IE0	0003h
2	2	Timer 0	TF0	000Bh
3	3	INT1	IE1	0013h
4	4	Timer 1	IF1	001Bh
5	6	UART	RI+TI	0023h
6	7	Timer 2	TF2+EXF2	002Bh
7	5	PCA	CF + CCFn (n = 0 - 4)	0033h
8	8	Keyboard	KBDIT	003Bh
9	9	-	-	0043h
10	10	SPI	SPIIT	004Bh

the SFR and RAM contents are preserved. The status of the Port pins during Power-Down mode is detailed in Table 59.

Note: VCC may be reduced to as low as V_{RET} during Power-Down mode to further reduce power dissipation. Take care, however, that VDD is not reduced until Power-Down mode is invoked.

Entering Power-Down Mode

To enter Power-Down mode, set PD bit in PCON register. The AT89C51RD2/ED2 enters the Power-Down mode upon execution of the instruction that sets PD bit. The instruction that sets PD bit is the last instruction executed.

Exiting Power-Down Mode

Note: If VCC was reduced during the Power-Down mode, do not exit Power-Down mode until VCC is restored to the normal operating level.

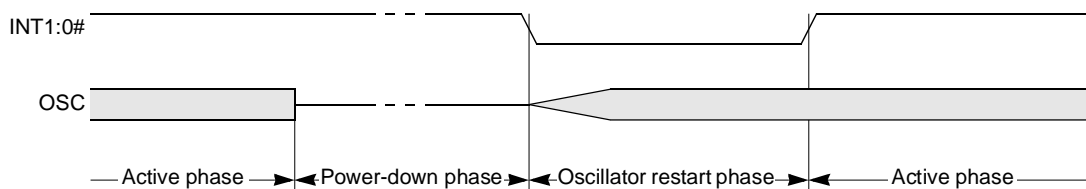
There are three ways to exit the Power-Down mode:

1. Generate an enabled external interrupt.
 - The AT89C51RD2/ED2 provides capability to exit from Power-Down using INT0#, INT1#.
 - Hardware clears PD bit in PCON register which starts the oscillator and restores the clocks to the CPU and peripherals. Using INTx# input, execution resumes when the input is released (see Figure 37). Execution resumes with the interrupt service routine. Upon completion of the interrupt service routine, program execution resumes with the instruction immediately following the instruction that activated Power-Down mode.

Note: The external interrupt used to exit Power-Down mode must be configured as level sensitive (INT0# and INT1#) and must be assigned the highest priority. In addition, the duration of the interrupt must be long enough to allow the oscillator to stabilize. The execution will only resume when the interrupt is deasserted.

Note: Exit from power-down by external interrupt does not affect the SFRs nor the internal RAM content.

Figure 37. Power-Down Exit Waveform Using INT1:0#



2. Generate a reset.
 - A logic high on the RST pin clears PD bit in PCON register directly and asynchronously. This starts the oscillator and restores the clock to the CPU and peripherals. Program execution momentarily resumes with the instruction immediately following the instruction that activated Power-Down mode and may continue for a number of clock cycles before the internal reset algorithm takes control. Reset initializes the AT89C51RD2/ED2 and vectors the CPU to address 0000h.

Table 69. Default Values

Mnemonic	Definition	Default value	Description
SBV	Software Boot Vector	FCh	
BSB	Boot Status Byte	0FFh	
SSB	Software Security Byte	FFh	
	Copy of the Manufacturer Code	58h	Atmel
	Copy of the Device ID #1: Family Code	D7h	C51 X2, Electrically Erasable
	Copy of the Device ID #2: Memories Size and Type	ECh	AT89C51RD2/ED2 64KB
	Copy of the Device ID #3: Name and Revision	EFh	AT89C51RD2/ED2 64KB, Revision 0

After programming the part by ISP, the BSB must be cleared (00h) in order to allow the application to boot at 0000h.

The content of the Software Security Byte (SSB) is described in Table 70 and Table 71.

To assure code protection from a parallel access, the HSB must also be at the required level.

Table 70. Software Security Byte

7	6	5	4	3	2	1	0
-	-	-	-	-	-	LB1	LB0

Bit Number	Bit Mnemonic	Description
7	-	Reserved Do not clear this bit.
6	-	Reserved Do not clear this bit.
5	-	Reserved Do not clear this bit.
4	-	Reserved Do not clear this bit.
3	-	Reserved Do not clear this bit.
2	-	Reserved Do not clear this bit.
1-0	LB1-0	User Memory Lock Bits See Table 71

The two lock bits provide different levels of protection for the on-chip code and data, when programmed as shown in Table 71.

Table 71. User Memory Lock Bits of the SSB

Program Lock Bits			Protection Description
Security Level	LB0	LB1	
1	1	1	No program lock features enabled.
2	0	1	ISP programming of the Flash is disabled.
3	X	0	Same as 2, also verify through ISP programming interface is disabled.

Note: X: Do not care

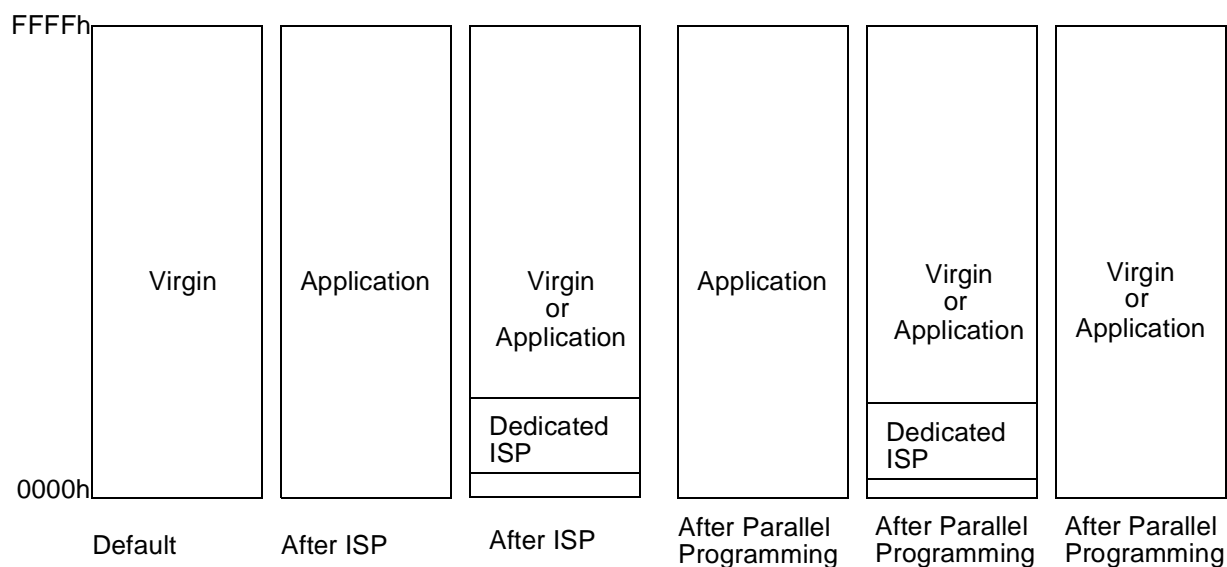
WARNING: Security level 2 and 3 should only be programmed after Flash verification.

Flash Memory Status

AT89C51RD2/ED2 parts are delivered in standard with the ISP ROM bootloader.

After ISP or parallel programming, the possible contents of the Flash memory are summarized in Figure 40:

Figure 40. Flash Memory Possible Contents



Memory Organization

When the $\overline{\text{EA}}$ pin is high, the processor fetches instructions from internal program Flash. If the $\overline{\text{EA}}$ pin is tied low, all program memory fetches are from external memory.

ISP Protocol Description

Physical Layer

The UART used to transmit information has the following configuration:

- Character: 8-bit data
- Parity: none
- Stop: 2 bits
- Flow control: none
- Baudrate: autobaud is performed by the bootloader to compute the baudrate chosen by the host.

Frame Description

The Serial Protocol is based on the Intel Hex-type records.

Intel Hex records consist of ASCII characters used to represent hexadecimal values and are summarized below.

Figure 45. Intel Hex Type Frame

Record Mark '.'	Reclen	Load Offset	Record Type	Data or Info	Checksum
1-byte	1-byte	2-bytes	1-byte	n-bytes	1-byte

- Record Mark:

Record Mark is the start of frame. This field must contain '.'.

- Reclen:

Reclen specifies the number of bytes of information or data which follows the Record Type field of the record.

- Load Offset:

Load Offset specifies the 16-bit starting load offset of the data bytes, therefore this field is used only for Data Program Record (see Section "ISP Commands Summary").

- Record Type:

Record Type specifies the command type. This field is used to interpret the remaining information within the frame. The encoding for all the current record types is described in Section "ISP Commands Summary".

- Data/Info:

Data/Info is a variable length field. It consists of zero or more bytes encoded as pairs of hexadecimal digits. The meaning of data depends on the **Record Type**.

- Checksum:

The two's complement of the 8-bit bytes that result from converting each pair of ASCII hexadecimal digits to one byte of binary, and including the **Reclen** field to and including the last byte of the **Data/Info** field. Therefore, the sum of all the ASCII pairs in a record after converting to binary, from the **Reclen** field to and including the **Checksum** field, is zero.

API Call Description

The IAP allows to reprogram a microcontroller on-chip Flash memory without removing it from the system and while the embedded application is running.

The user application can call some Application Programming Interface (API) routines allowing IAP. These API are executed by the bootloader.

To call the corresponding API, the user must use a set of Flash_api routines which can be linked with the application.

Example of Flash_api routines are available on the Atmel web site on the software application note:

C Flash Drivers for the AT89C51RD2/ED2

The API calls description and arguments are shown in Table 76.

Process

The application selects an API by setting R1, ACC, DPTR0 and DPTR1 registers.

All calls are made through a common interface "USER_CALL" at the address FFF0h.

The jump at the USER_CALL must be done by LCALL instruction to be able to come-back in the application.

Before jump at the USER_CALL, the bit ENBOOT in AUXR1 register must be set.

Constraints

The interrupts are not disabled by the bootloader.

Interrupts must be disabled by user prior to jump to the USER_CALL, then re-enabled when returning.

Interrupts must also be disabled before accessing EEPROM Data then re-enabled after.

The user must take care of hardware watchdog before launching a Flash operation.

Table 76. API Call Summary

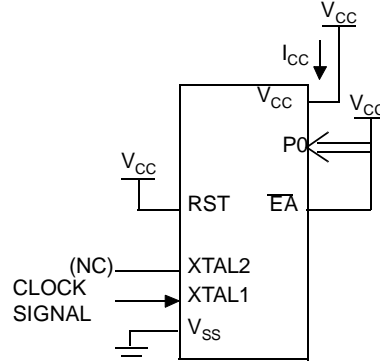
Command	R1	A	DPTR0	DPTR1	Returned Value	Command Effect
READ MANUF ID	00h	XXh	0000h	XXh	ACC = Manufacturer Id	Read Manufacturer identifier
READ DEVICE ID1	00h	XXh	0001h	XXh	ACC = Device Id 1	Read Device identifier 1
READ DEVICE ID2	00h	XXh	0002h	XXh	ACC = Device Id 2	Read Device identifier 2
READ DEVICE ID3	00h	XXh	0003h	XXh	ACC = Device Id 3	Read Device identifier 3
ERASE BLOCK	01h	XXh	DPH = 00h	00h	ACC = DPH	Erase block 0
			DPH = 20h			Erase block 1
			DPH = 40h			Erase block 2
			DPH = 80h			Erase block 3
			DPH = C0h			Erase block 4
PROGRAM DATA BYTE	02h	Vaue to write	Address of byte to program	XXh	ACC = 0: DONE	Program up one data byte in the on-chip flash memory.

Maximum total I_{OL} for all output pins: 71 mA

If I_{OL} exceeds the test condition, V_{OL} may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.

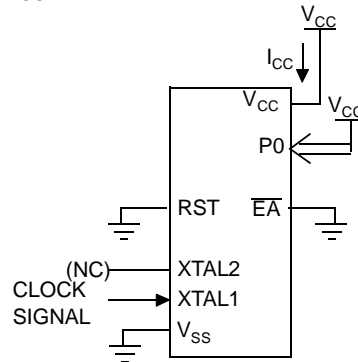
7. The maximum dV/dt value specifies the maximum V_{CC} drop to insure no internal POR/PFD reset.

Figure 52. I_{CC} Test Condition, Active Mode



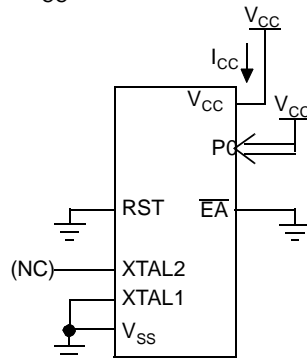
All other pins are disconnected.

Figure 53. I_{CC} Test Condition, Idle Mode



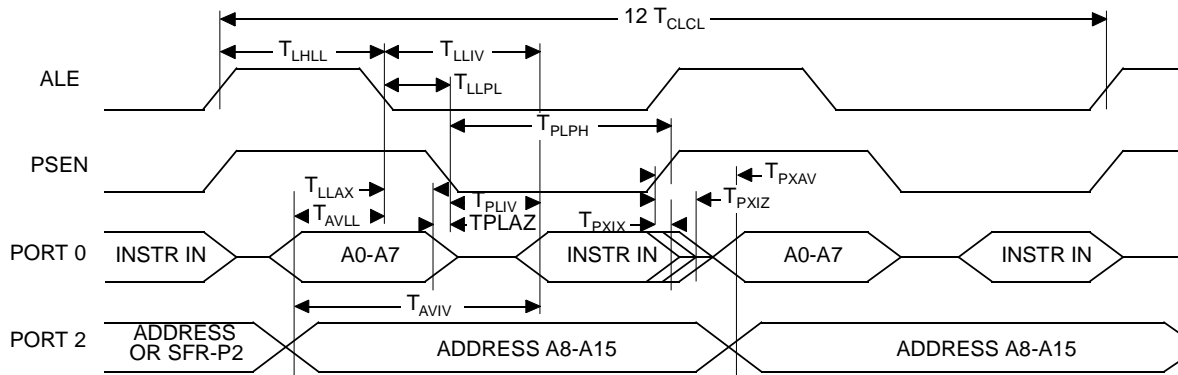
All other pins are disconnected.

Figure 54. I_{CC} Test Condition, Power-down Mode



All other pins are disconnected.

External Program Memory Read Cycle

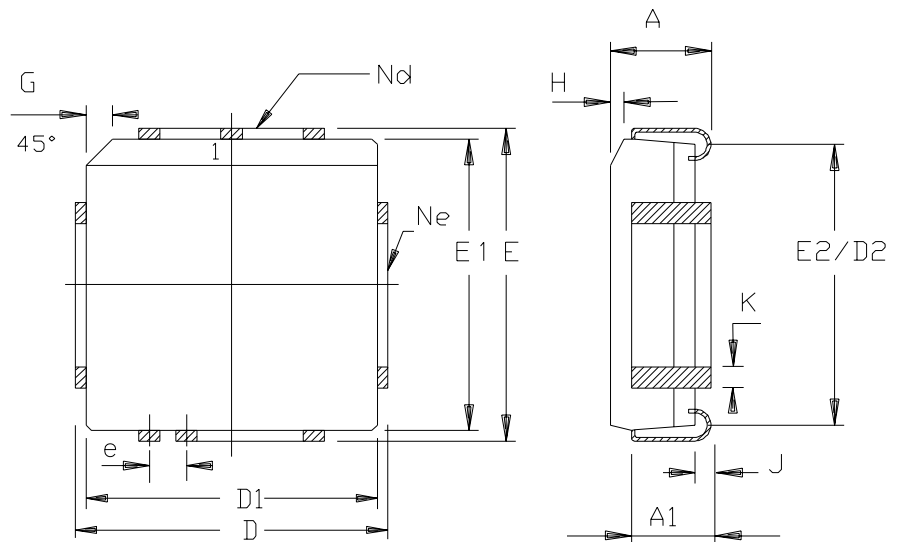


External Data Memory Characteristics

Table 80. Symbol Description

Symbol	Parameter
T_{RLRH}	\overline{RD} Pulse Width
T_{WLWH}	\overline{WR} Pulse Width
T_{RLDV}	\overline{RD} to Valid Data In
T_{RHDZ}	Data Hold After \overline{RD}
T_{RHDZ}	Data Float After \overline{RD}
T_{LLDV}	ALE to Valid Data In
T_{AVDV}	Address to Valid Data In
T_{LLWL}	ALE to \overline{WR} or \overline{RD}
T_{AVWL}	Address to \overline{WR} or \overline{RD}
T_{QVWX}	Data Valid to \overline{WR} Transition
T_{QVWH}	Data Set-up to \overline{WR} High
T_{WHQX}	Data Hold After \overline{WR}
T_{RLAZ}	\overline{RD} Low to Address Float
T_{WHLH}	\overline{RD} or \overline{WR} High to ALE high

PLCC68



	MM		INCH	
A	4.20	5.08	.165	.200
A1	2.29	3.30	.090	.130
D	25.02	25.27	.985	.995
D1	24.13	24.33	.950	.958
D2	22.61	23.62	.890	.930
E	25.02	25.27	.985	.995
E1	24.13	24.33	.950	.958
E2	22.61	23.62	.890	.930
e	1.27	BSC	.050	BSC
G	1.07	1.22	.042	.048
H	1.07	1.42	.042	.056
J	0.51	—	.020	—
K	0.33	0.53	.013	.021
Nd	17		17	
Ne	17		17	
PKG STD	00			